

1.6X0.8mm SMD CHIP LED LAMP

Part Number: APTD1608SECK/J3-PF Hyper Red

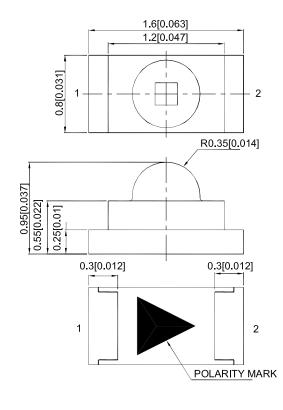
Features

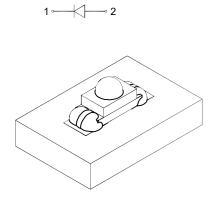
- 1.6mmX0.8mm SMT LED, 0.95mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Hyper Red device is based on light emitting diode chip made from AlGaInP.

Package Dimensions





- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.



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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APTD1608SECK/J3-PF	Hyper Red (AlGaInP)	Water Clear	1900	2700	- 60°
			*500	*800	

- $1.\,\theta1$ / 2 is the angle from optical centerline where the luminous intensity is 1 / 2 of the optical peak value.
- Luminous intensity / luminous Flux: + / -15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD [1]	Dominant Wavelength	Hyper Red	625		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	20		nm	IF=20mA
С	Capacitance	Hyper Red	27		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Hyper Red	2.2	2.8	V	IF=20mA
lr	Reverse Current	Hyper Red		10	uA	V _R =5V

- Notes:

 1. Wavelength: + / -1nm.

 2. Forward Voltage: + / -0.1V.

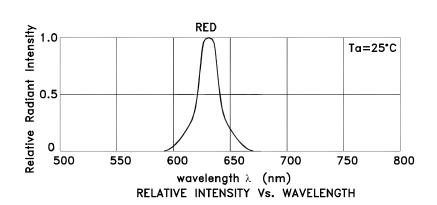
 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.
- Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red	Units	
Power dissipation	84	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	150	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

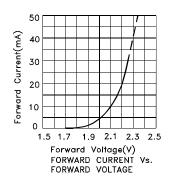
1. 1 / 10 Duty Cycle, 0.1ms Pulse Width.

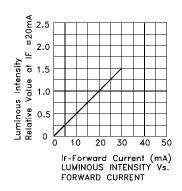
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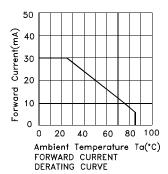


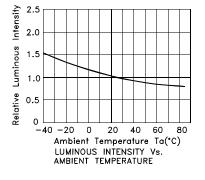
Hyper Red

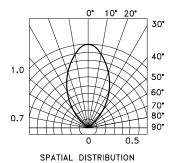
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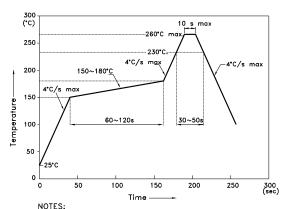
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



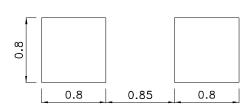
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

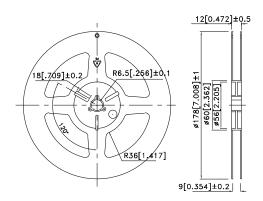
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

 3.Number of reflow process shall be 2 times or less.

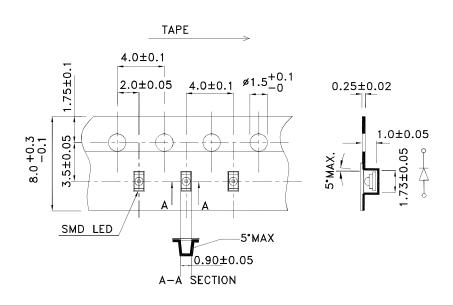
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Reel Dimension



Tape Dimensions (Units: mm)



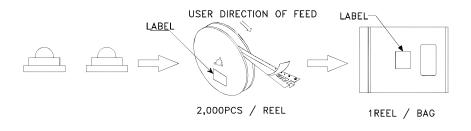
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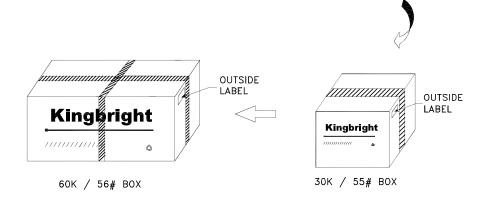
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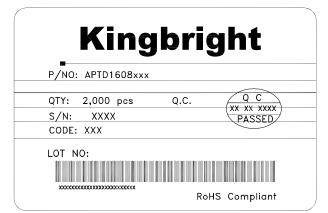
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PACKING & LABEL SPECIFICATIONS

APTD1608SECK/J3-PF







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